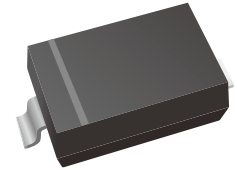


Switching Diodes

Features

- For surface mounted applications
- Fast reverse recovery time
- Ideal for automated placement
- Lead free in comply with EU RoHS 2011/65/EU directives



Mechanical Data

- Case: SOD-123
- Terminals: Solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end

Ordering Information

Part Number	Marking	Shipping	Reel
LT4148WA-TR3	T4 or G1	3000PCS Tape&Reel	7 inchs
LT4148WA-TR12	T4 or G1	12000PCS Tape&Reel	13 inchs

Absolute Maximum Ratings (Ta=25°C)

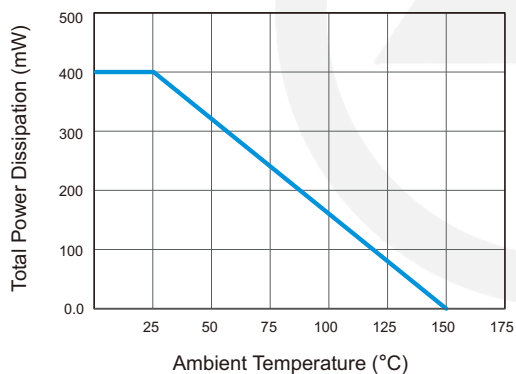
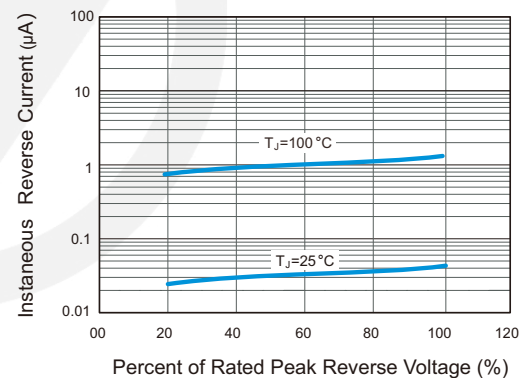
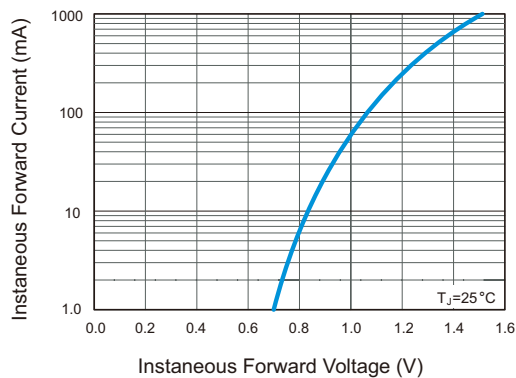
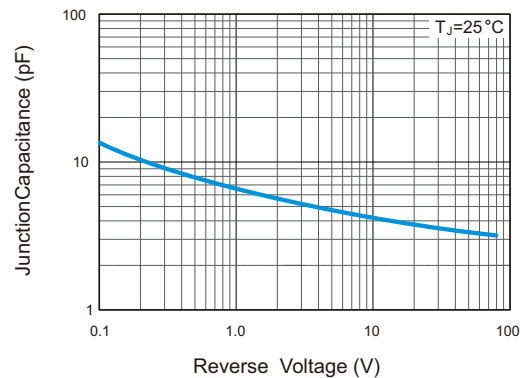
Parameter	Symbol	LT4148WA	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	100	V
Maximum RMS voltage	V_{RMS}	75	V
Average Rectified Forward Current	$I_{F(AV)}$	200	mA
Non-repetitive Peak Forward Surge Current	I_{FSM}	0.5 1 4	A
Total Power Dissipation	P_{tot}	400	mW
Typical Thermal Resistance (Note1)	$R_{\theta JA}$ $R_{\theta JC}$	280 100	°C/W
Operating and Storage Temperature Range	T_j, T_{stg}	-55 ~ +150	°C

Note: (1) P.C.B. mounted with 5mm × 5mm copper pad areas.

Characteristics (Ta=25°C)

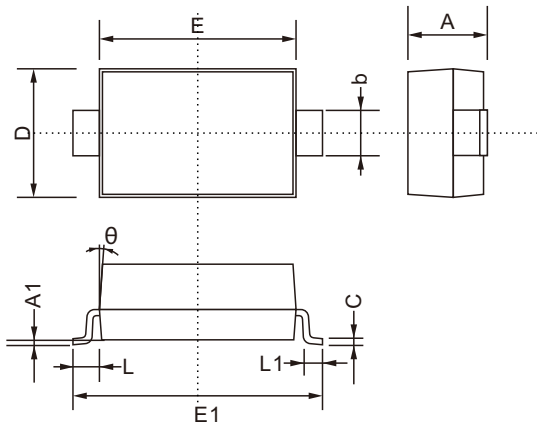
Parameter	Symbol	LT4148WA	Unit
Reverse Breakdown Voltage at $I_R=1\mu A$	$V_{(BR)R}$	75	V
Maximum Forward Voltage at 1 mA at 10 mA at 50 mA at 150 mA	V_F	0.715 0.855 1.00 1.25	V
Peak Reverse Current at $V_R=20V$ $T_J=25^\circ C$ at $V_R=75V$ $T_J=25^\circ C$	I_R	0.025 1	μA
Typical Junction Capacitance $f=1MHz, V_R=0V$	C_j	2	pF
Maximum Reverse Recovery Time (Note2)	t_{rr}	4	ns

Note: (2) Measured with $I_F=I_R=10mA, I_{rr}=0.1 \times I_R, R_L=100\Omega$

Characteristics Curve
Fig.1 Power Derating Curve

Fig.2 Typical Reverse Characteristics

Fig.3 Typical Instantaneous Forward Characteristics

Fig.4 Typical Junction Capacitance


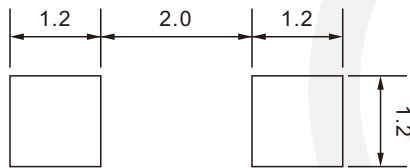
SOD-123 Package Outline

Unit: mm



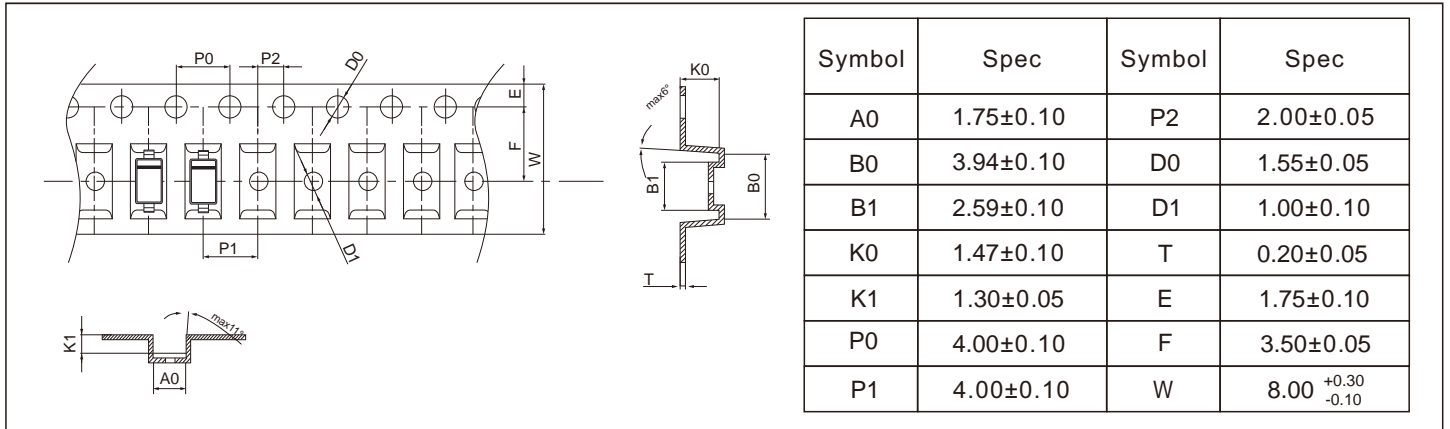
SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	0.900	1.300
A1	0.000	0.200
b	0.450	0.750
C	0.080	0.230
D	1.500	1.800
E	2.500	2.800
E1	3.550	3.900
L	0.5REF	
θ	8°	

SOD-123 Suggested Pad Layout



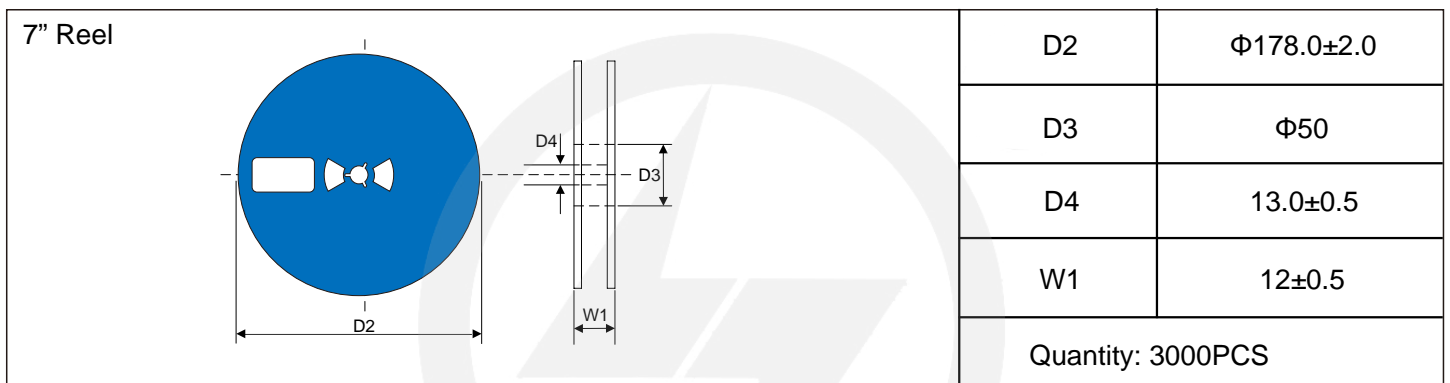
- Note:
1. Controlling dimension: in millimeters.
 2. General tolerance: $\pm 0.05\text{mm}$
 3. The pad layout is for reference purpose only.

Carrier Tape Dimensions



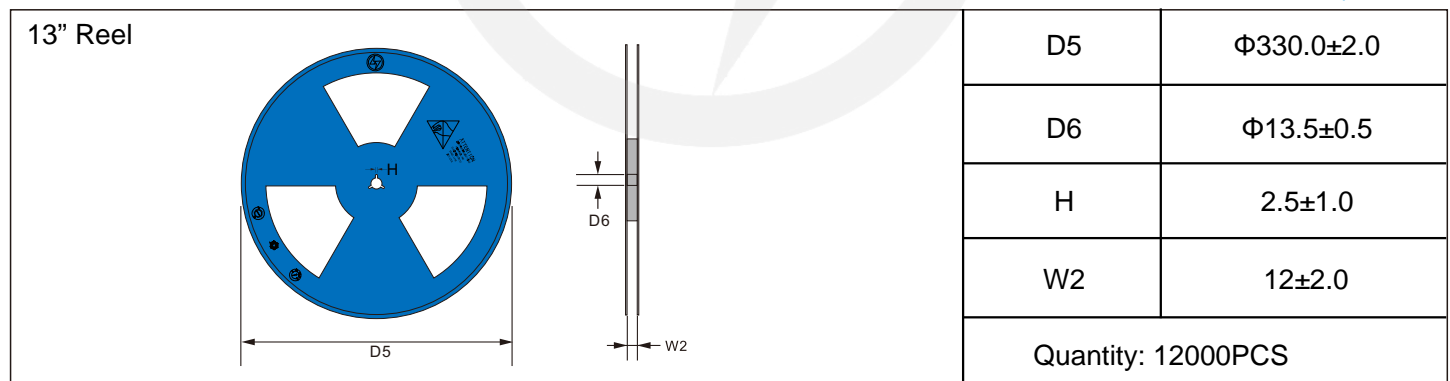
Reel Dimensions

Unit : mm

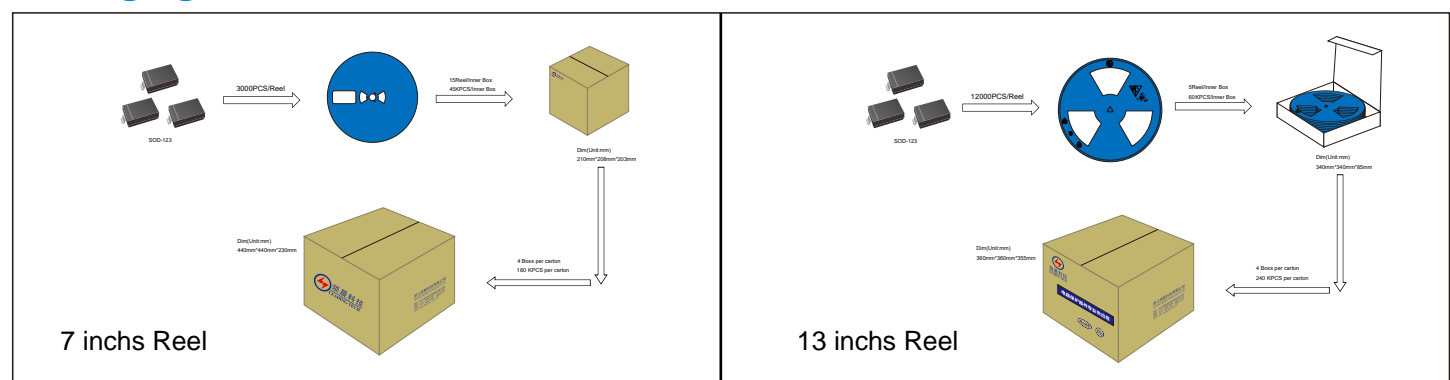


Reel Dimensions

Unit : mm

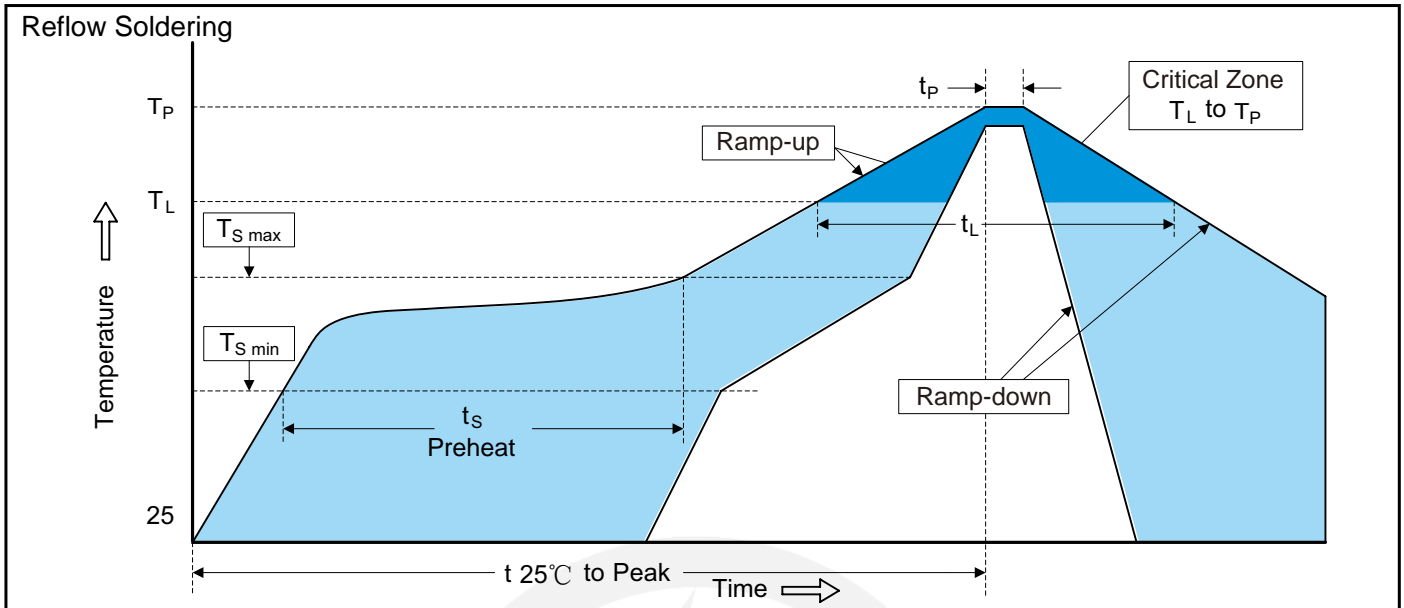


Packaging





Recommended Soldering Conditions



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T _L to T _P)	3°C/second max.
Preheat	
-Temperature Min (T _{S min})	150°C
-Temperature Max (T _{S max})	200°C
-Time (min to max) (t _s)	60-180 seconds
T _{S max} to T _L	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T _L)	217°C
-Time (t _L)	60-150 seconds
Peak Temperature (T _P)	260°C
Time within 5°C of actual Peak Temperature (t _p)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

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Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision content	Revision Reason	Revision Person	Note
01	2024.3.14	2024.3.14	3.0	New File	/	Ding	
02	2025.06.17	2025.06.17	3.1	Update packaging information	/	Ding	